



### DUAL SURFACE MOUNT LOW LEAKAGE DIODE

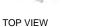
### **Features**

- Surface Mount Package Ideally Suited for Automated Insertion
- Very Low Leakage Current
- Lead Free/RoHS Compliant (Note 3)

### **Mechanical Data**

- Case: SOT-23 •
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.008 grams (approximate)





TOP VIEW Internal Schematic

# **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	85	V	
RMS Reverse Voltage		V <sub>R(RMS)</sub>	60	V	
Forward Continuous Current (Note 2)			160 140	mA	
Repetitive Peak Forward Current (Note 2)		I <sub>FRM</sub>	500	mA	
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0 0.5	A	

SOT-23

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ ext{ heta}JA}$	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	O°

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V <sub>(BR)R</sub>	85		_	V	I <sub>R</sub> = 100μA
Forward Voltage	V <sub>F</sub>	_	_	0.90 1.0 1.1 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Leakage Current (Note 1)	I <sub>R</sub>	—	_	5.0 80	nA nA	V <sub>R</sub> = 75V V <sub>R</sub> = 75V, T <sub>J</sub> = 150°C
Total Capacitance	CT	_	3	_	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>	—	_	3.0	μs	$I_F = I_R = 10$ mA, $I_{rr} = 0.1 \times I_R$ , $R_L = 100\Omega$

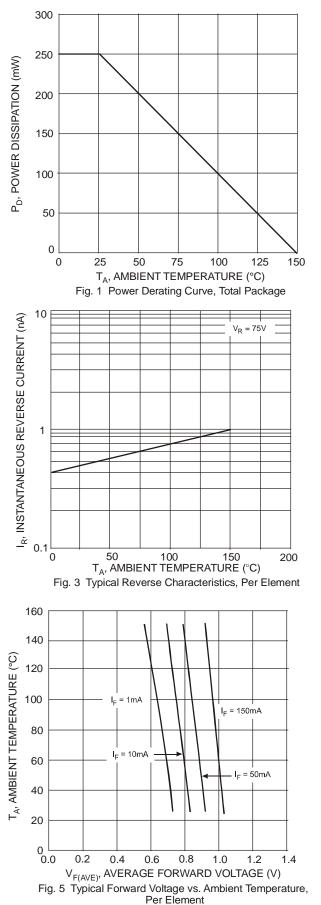
1. Short duration pulse test used to minimize self-heating effect.

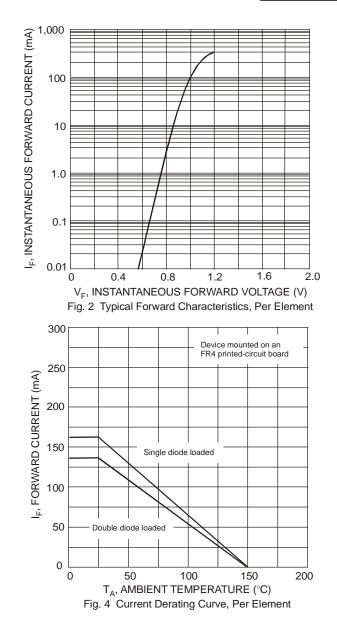
Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 2. 3. No purposefully added lead.

Notes:











# Ordering Information (Note 4)

Part Number	Case	Packaging
BAW156-7-F	SOT-23	3000/Tape & Reel

Notes: 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**

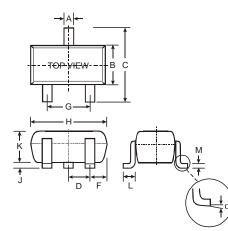


K53 = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

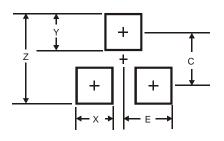
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	К	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	eb	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	t l	lov	Dec
Code	1	2	2	3	4	5	6		7	8	9	0		Ν	D

# **Package Outline Dimensions**



SOT-23						
Dim	Min	Max				
Α	0.37	0.51				
В	1.20	1.40				
С	2.30	2.50				
D	0.89	1.03				
F	0.45	0.60				
G	1.78	2.05				
Н	2.80	3.00				
J	0.013	0.10				
Κ	0.903 1.10					
L	0.45 0.61					
Μ	0.085	0.180				
α	0° 8°					
All Dir	All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35

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